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20 V, 1.5 A low VF MEGA Schottky barrier rectifier Rev. 1 — 6 March 2012

Product data sheet

Product profile 1.

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD1608 (DFN1608D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

1.2 Features and benefits

- Average forward current: I_{F(AV)} ≤ 1.5 A
- Reverse voltage: V_R ≤ 20 V
- Low forward voltage $V_F \le 420 \text{ mV}$
- Low reverse current

1.3 Applications

Quick reference data

Table 1

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply

1.4 Quick reference data

LED backlight for mobile application

- AEC-Q101 qualified
- Solderable side pads
- Package height typ. 0.37 mm
- Ultra small and leadless SMD plastic package
- Low power consumption applications
- Ultra high-speed switching
- Reverse polarity protection

Table 1.	QUICK reference uala						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ < 0.5; f = 20 kHz; T _{amb} ≤ 100 °C; square wave	<u>[1]</u>	-	-	1.5	А
		δ < 0.5; f = 20 kHz; T _{sp} ≤ 140 °C; square wave		-	-	1.5	А
V _R	reverse voltage	T _j = 25 °C		-	-	20	V
V _F	forward voltage	I_{F} = 1.5 A; pulsed; t_{p} \leq 300 μ s; δ \leq 0.02; T_{j} = 25 $^{\circ}\text{C}$		-	375	420	mV
I _R	reverse current	V _R = 10 V; T _j = 25 °C		-	70	350	μA
t _{rr}	reverse recovery time	I_{R} = 0.5 A; I_{F} = 0.5 A; $I_{R(meas)}$ = 0.1 A; T_{j} = 25 °C		-	5	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.



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2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode ^[1]		. 54 -
2	A	anode		1 <u>-</u> 2 sym001
			Transparent top view	
			SOD1608 (DFN1608D-2)	

[1] The marking bar indicates the cathode.

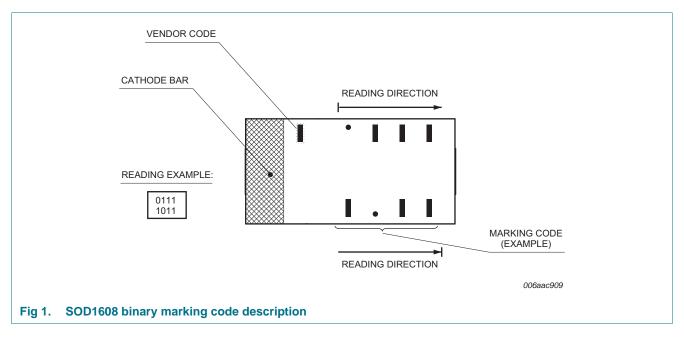
3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMEG2015EPK	DFN1608D-2	Leadless ultra small plastic package; 2 terminals	SOD1608			

4. Marking

Table 4.Marking codes

Type number	Marking code
PMEG2015EPK	1100 0000



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5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	20	V
I _F	forward current	T _{sp} ≤ 135 °C		-	2.1	А
$I_{F(AV)}$	average forward current	δ < 0.5; f = 20 kHz; square wave; T _{amb} ≤ 100 °C	<u>[1]</u>	-	1.5	A
		δ < 0.5; f = 20 kHz; square wave; T _{sp} ≤ 140 °C		-	1.5	A
I _{FRM}	repetitive peak forward current	$t_p = 1 ms; \delta = 0.25$		-	4	А
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	5	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2][3]	-	415	mW
			[4][3]	-	895	mW
			[1][3]	-	1565	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 6.Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance	in free air [1][2][3] [1][4][3]	<u>[1][2][3]</u>	-	-	300	K/W
	from junction to ambient		-	-	140	K/W	
	ampient		[1][5][3]	-	-	80	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		<u>[6]</u>	-	-	20	K/W

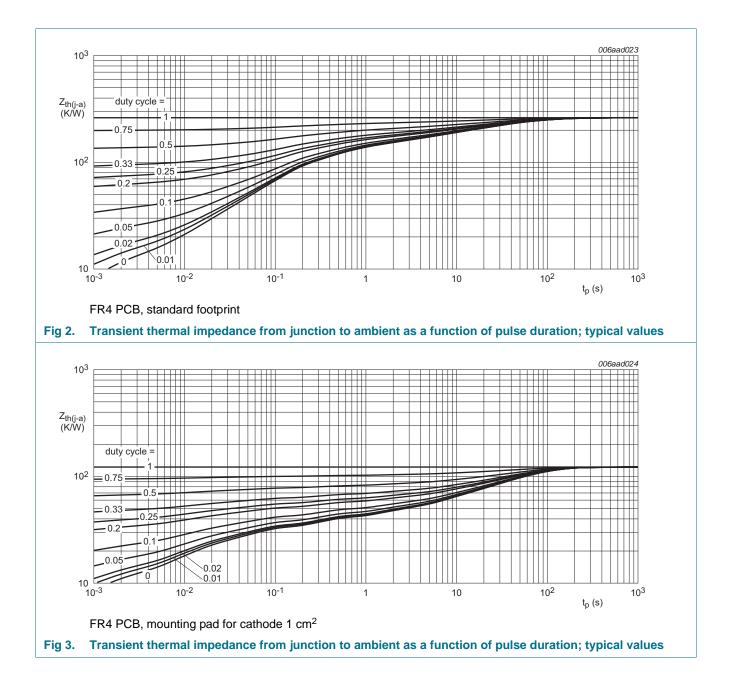
[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_Rare a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

- [3] Reflow soldering is the only recommended soldering method.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [5] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [6] Soldering point of cathode tab.

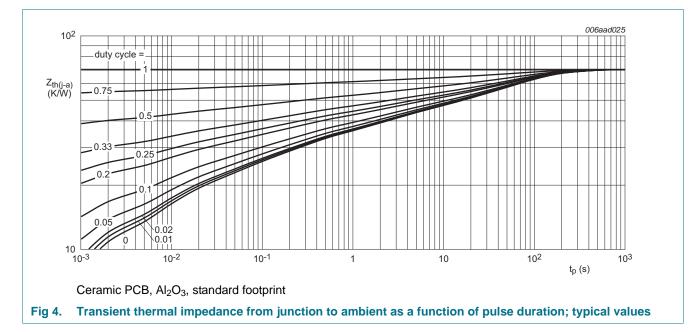
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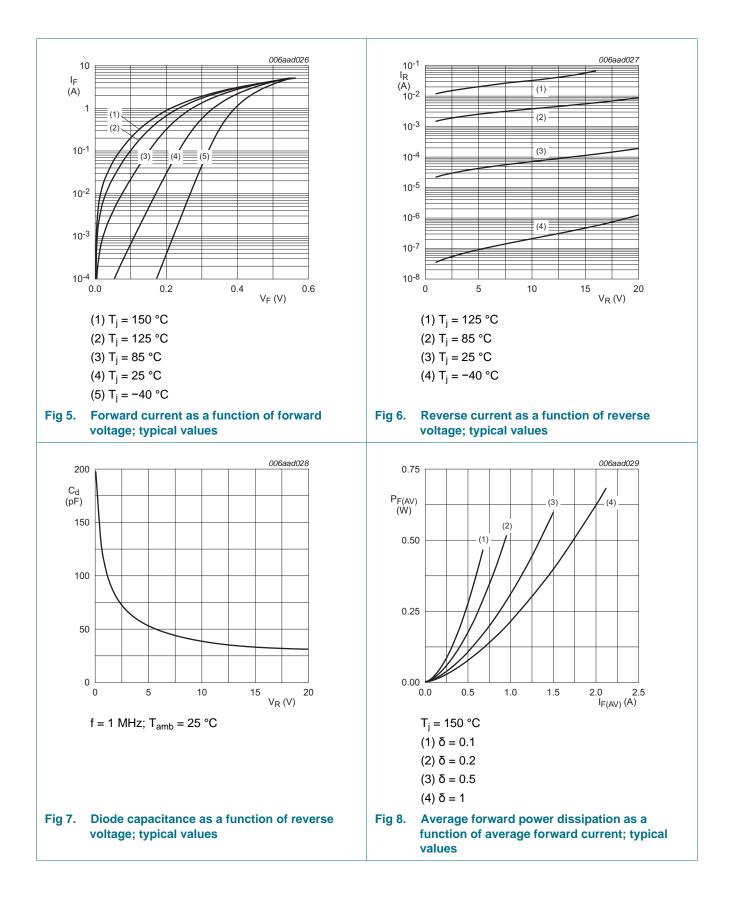


7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I_F = 100 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	230	260	mV
		I_F = 500 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	290	330	mV
		I _F = 1 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	330	380	mV
		I_F = 1.5 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	375	420	mV
I _R reverse current	reverse current	$V_R = 10 \text{ V}; \text{ T}_j = 25 \text{ °C}$	-	70	350	μA
		$V_R = 20 \text{ V}; \text{ T}_j = 25 \text{ °C}$	-	220	900	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	105	120	pF
		$V_R = 10 V$; f = 1 MHz; T _j = 25 °C	-	40	50	pF
t _{rr}	reverse recovery time	I_{F} = 0.5 A; I_{R} = 0.5 A; $I_{R(meas)}$ = 0.1 A; T_{j} = 25 °C	-	5	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s}; \text{ T}_j = 25 \text{ °C}$	-	320	-	mV

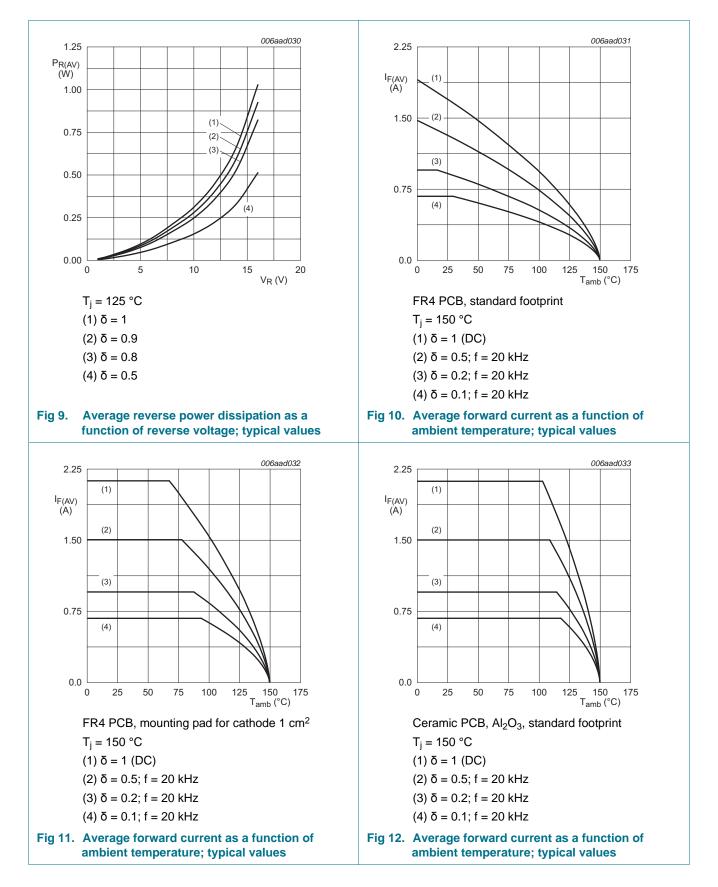
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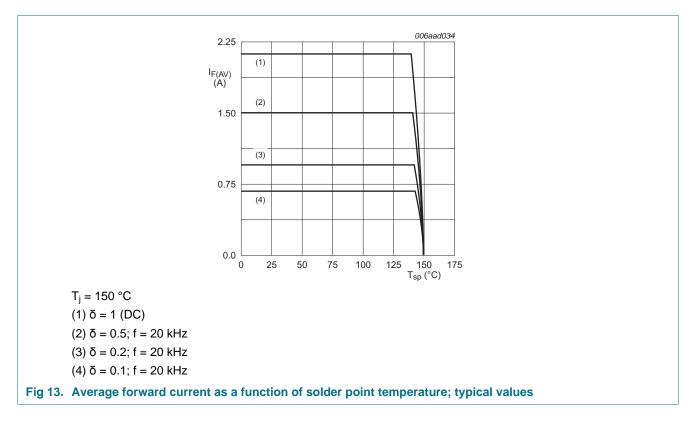
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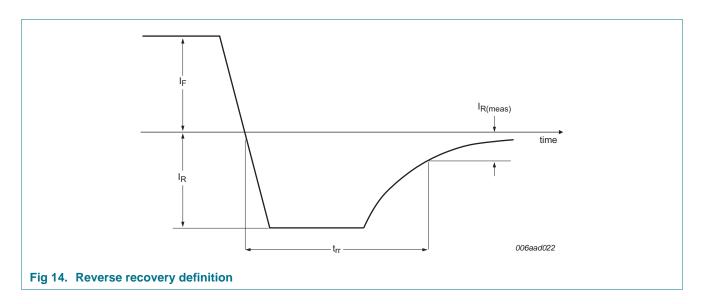


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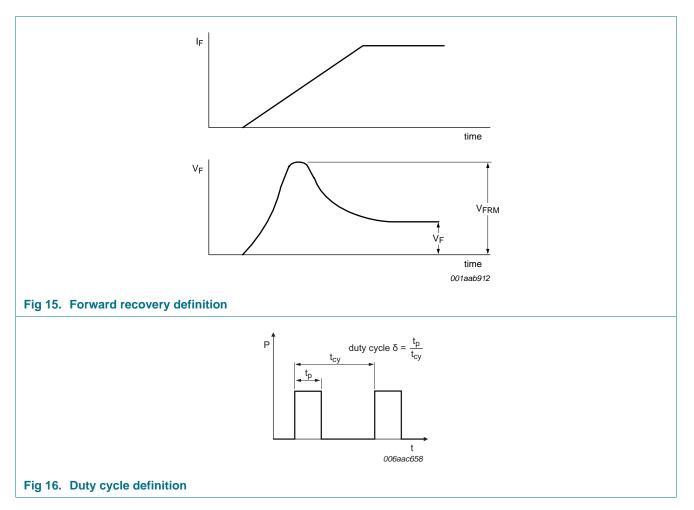


8. Test information



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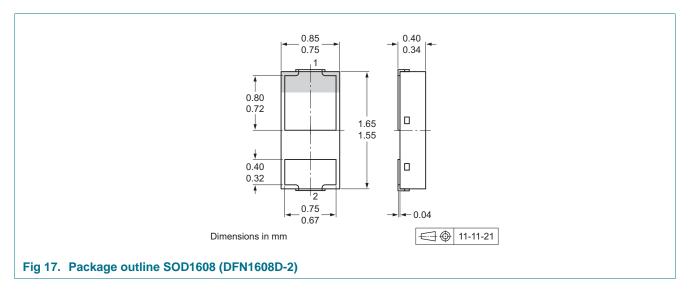
The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

20 V, 1.5 A low VF MEGA Schottky barrier rectifier

Package outline 9.



10. Soldering

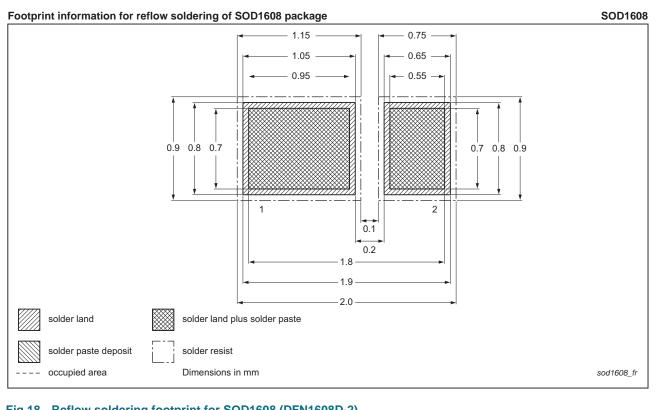


Fig 18. Reflow soldering footprint for SOD1608 (DFN1608D-2)

PMEG2015EPK **Product data sheet**

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11. Revision history

Table 8. Revision h	Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG2015EPK v.1	20120306	Product data sheet	-	-				

20 V, 1.5 A low VF MEGA Schottky barrier rectifier

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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